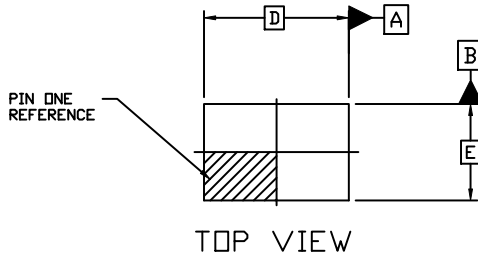


SCALE 4:1

WQFN12 3.0x2.0, 0.5P
CASE 510BM
ISSUE C

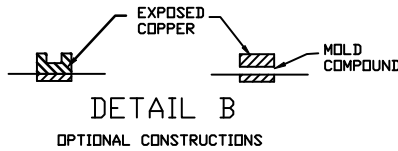
DATE 09 DEC 2019



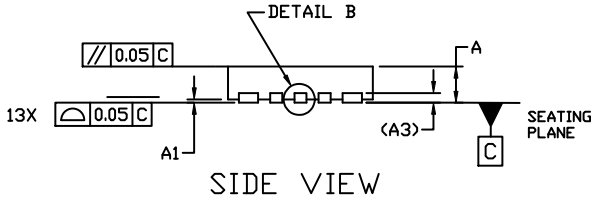
TOP VIEW

NOTES:

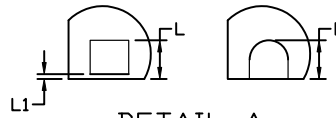
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b AND b1 APPLY TO THE PLATED TERMINALS AND ARE MEASURED BETWEEN 0.15 AND 0.25MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.



DETAIL B
OPTIONAL CONSTRUCTIONS

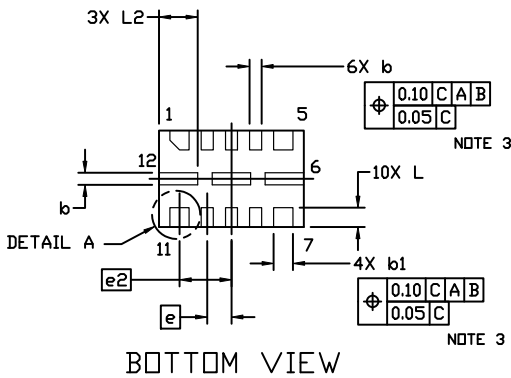


SIDE VIEW

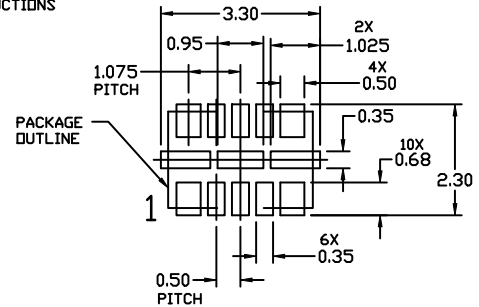


DETAIL A
OPTIONAL CONSTRUCTIONS

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.70	0.75	0.80
A1	0.00	---	0.05
A3	0.20 REF		
b	0.20	0.25	0.30
b1	0.35	0.40	0.45
D	2.90	3.00	3.10
E	1.90	2.00	2.10
e	0.50 BSC		
e2	1.075 BSC		
L	0.30	0.40	0.50
L1	0.00	---	0.15
L2	0.70	0.80	0.90



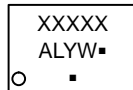
BOTTOM VIEW



RECOMMENDED
MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SLDERRM/D.

GENERIC MARKING DIAGRAM*



- XXXX = Specific Device Code
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WQFN12 3.0X2.0, 0.5P	PAGE 1 OF 1

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